

# RL78/G24 Motor Control Evaluation Kit

# User's Manual

# For Your Safety

Be sure to read this manual before using the RL78/G24 Motor Control Evaluation Kit (RTK0EMG24SS00000BJ) (this product).

Please follow the instructions in this manual when using the product.

Keep this manual near the product so you can refer to it whenever necessary.

Transfer or sale of the product to third parties is prohibited without written approval.

The purchaser or importer of the product is responsible for ensuring compliance with local regulations. In addition, the customer is responsible for ensuring that the product is handled correctly and safely, in accordance with the laws of the customer's country (region).

The manual for the product, and specification (the documents) are the tool that was developed for the function and performance evaluation of Renesas Electronics semiconductor device (Renesas Electronics device) mounted on the product, and not guarantee the same quality, function and performance.

By purchasing the product or downloading the documents from Renesas Electronics website, the the support services provided by Renesas Electronics are not guaranteed.

All information contained in this manual represents information on products at the time of publication of this manual. Please note that the product data, specification, sales offices, contents of website, address, etc., are subject to change by Renesas Electronics Corporation without notice due to product improvements or other reasons. Please confirm the latest information on Renesas Electronics website.

In this manual, safety symbols related to the product are described as below.

■ The degree of injury to persons or damage to property that could result if the designated content in this manual is not followed is indicated as follows.

<b>A</b> Danger	Indicates content that, if not followed, could result in death or serious injury*1 to the user, and which is highly urgent.
<b>Warning</b>	Indicates content that, if not followed, could result in death or serious injury to the user.
<b>A</b> Caution	Indicates content that, if not followed, could result in injury*2 to persons or physical damages.*3

- Note 1. Serious injury refers to conditions resulting in persistent after-effects and for which treatment would necessitate hospitalization or regular hospital visits, such as loss or impairment of eyesight, burns (high- or low-temperature), electric shock, bone fracture, or poisoning.
- Note 2. Injury refers to conditions for which treatment would necessitate hospitalization or regular hospital visits
- Note 3. Physical damage refers to damage affecting the wider surroundings, such as the user's home or property.

- Requirements related to the handling of the product are classified into the following categories.
- Marks indicating that an action is prohibited.



General Prohibition
The indicated action is prohibited.



Example: Do Not Touch!

Touching the specified location could result in injury.

Marks indicating that an action is prohibited.



General Caution Indicates a general need for caution that is not specified.



Example: Caution – Hot! Indicates the possibility of injury due to high temperature.

Marks directing that the specified action is required.



General Instruction
The specified action is required.



Example: Turn Off (Disconnect) Power Supply!

Instructs the user to turn off (disconnect) the power supply to the product.

# Warnings Regarding Use of the Product

# Danger Items





The product should be used only by persons (users) having a thorough knowledge of electrical and mechanical components and systems, a full knowledge of the risks associated with handling them, and training in inverter motor control and handling motors, or equivalent skills. Users should be limited to persons who have carefully read the Caution Items contained in this manual.



Unlike typical equipment, the product has no protective case to ensure safety, and it contains moving parts and high-temperature components that could be dangerous. Do not touch the evaluation board or cables while power is being supplied.



Carefully check to make sure that there are no pieces of conductive materials or dust adhering to the board, connectors, and cables.

There are moving parts, driven by a motor. Do not touch the motor while power is being supplied.

Ensure that the motor is insulated and placed in a stable location before supplying power.

# ■ Warning Items

# **Warning**



Caution – Rotating Parts!

The system includes a motor. Touching the rotating shaft could cause high-temperature burns or injury.

Always insert plugs, connectors, and cables securely, and confirm that they are fully inserted. Incomplete connections could cause fire, burns, electric shock, or injury.



Use the power supply apparatus specified in the manual.

Failure to do so could cause fire, burns, electric shock, injury, or malfunction.

Disconnect the power supply and unplug all cables when the system will not be used for a period of time or when moving the system.

Failure to do so could cause fire, burns, electric shock, or malfunction.

This will protect the system against damage due to lightning.

Use a mechanism (switch, outlet, etc.) located within reach to turn off (disconnect) the power supply.

In case of emergency, it may be necessary to cut off the power supply quickly.



Turn off the power supply immediately if you notice abnormal odor, smoke, abnormal sound, or overheating.

Continuing to use the system in an abnormal condition could cause fire, burns, or electric shock.



Do Not Disassemble, Modify, or Repair!

Failure to do so could cause fire, burns, electric shock, injury, or malfunction.

Do not use the product for any purpose other than initial evaluation of motor control in a testing room or lab.



Do not integrate the product or any part of it into other equipment.

Do not insert or remove cables or connectors when the product is powered on.

The product has no safety case.

Failure to observe the above could cause fire, electric shock, burns, or malfunction.

The product may not perform as expected if used for other than its intended purpose.

# ■ Caution Items





Caution - Hot!

The motor gets hot. Touching it could cause high-temperature burns.



Follow the procedure specified in the manual when powering the system on or off. Failure to do so could cause overheating or malfunction.

# **Summary**

The RL78/G24 Motor Control Evaluation Kit (RTK0EMG24SS00000BJ) is a motor control evaluation kit that enables evaluation of PMSM control using the RL78/G24 motor control microcontroller.

This user's manual describes the proper handling of the product.

In addition, this product supports the support tool for motor control development manufactured by Renesas Electronics (Renesas Motor Workbench: RMW). RMW combines convenient functions for motor control evaluation, such as real-time waveform display of microcontroller internal variables and automatic extraction of vector control parameters.

#### **Onboard Renesas Electronics Products**

Microcontroller : R7F101GLG2DFB (RL78/G24 microcontroller)\*

Gate Driver : HIP2101IBZ

MOSFET : RJK0703DPP-A0

DC-DC Regulator : ISL8560IRZ, ISL85003FRZ

Operational Amplifier : READ2302GSP

<sup>\*:</sup> All products of the RL78/G24 group (with ordering part numbers of R7F101Gxxxxxx#xx0; each x indicates a specific letter or numeral) have restrictions. For more information, RENESAS TECHNICAL UPDATE (TN-RL\*-A0127A/E) for more information.

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#### 1. Overview

This user's manual describes a control evaluation kit that drives PMSM using the RL78/G24 microcontroller. The features of the evaluation kit are shown below.

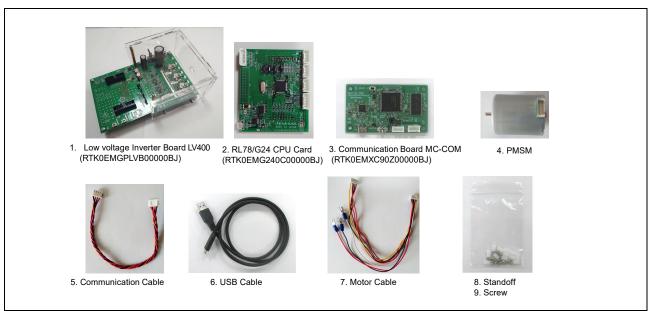
- (1) Evaluation with the "RL78/G24" motor control microcontroller is possible.
- (2) PMSM can be driven.
- (3) Can detect 3-shunt current and 1-shunt current.
- (4) Input voltage of 12V to 50V. (The customer must provide their own power supply for this product.)
- (5) Output peak current: 30A
- (6) Supports various sensor inputs (such as encoder and hall sensors), serial communications.
- (7) Motor control development support tool RMW available.
- (8) Interchangeable with compatible CPU cards.

(Renesas Electronics products: RTK0EML240C03000BJ, RTK0EML130C06000BJ, Desktop Lab products: T5103, T5101)

#### 2. Product Contents

This kit consists of the following parts.

- 1. Low voltage Inverter Board LV400 (RTK0EMGPLVB00000BJ) x1
- 2. RL78/G24 CPU Card (RTK0EMG240C00000BJ) x1
- 3. Communication Board MC-COM (RTK0EMXC90Z00000BJ) x1
- 4. PMSM (TG-55L-KA: TSUKASA Co., Ltd. product) x1
- 5. Communication Cable x1
- 6. USB Cable x1
- 7. Motor Cable x1
- 8. Standoff x 4
- 9. Screw x 4



**Figure 2-1 Product Configuration** 

# 3. Hardware Overview

The RL78/G24 Motor Control Evaluation Kit (RTK0EMG24SS00000BJ) consists of an inverter board, CPU card and communication board. The specifications are shown below.

Table 3.1 Specifications of RL78/G24 Motor Control Evaluation Kit (RTK0EMG24SS00000BJ)

Item	-		- ,	
Kit model name  Kit configuration  Inverter board LV400 RTK0EMGPLVB00000BJ  CPU card RTK0EMG240C00000BJ  Communication board RTK0EMXC90Z00000BJ  PMSM TG-55L-KA (TSUKASA Co., Ltd.)  Inverter board - CPU card: Non-isolated  Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Board size  Inverter board LV400: 100mm(W)×160mm(H)  CPU card: 79mm(W)×66mm(H)  Communication board - 89mm(W)×52mm(H)  Heat dissipation measures  Operating temperature  RTK0EMG24SS00000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB0000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB000000BJ  RTK0EMGPLVB00000BJ  RTK0EMGPLVB0000BJ  RTK0EMGPLVB0000BJ  RTK0EMGPLVB0000BJ  RTK0EMGPLVB0000BJ  RTK0EMGPLVB0000BJ  RTK0EMCPUCONOB  RTK0EMCP	Item	Specification		
Kit configuration  Inverter board LV400 RTK0EMGPLVB00000BJ CPU card RTK0EMG240C00000BJ Communication board RTK0EMC90Z00000BJ PMSM TG-55L-KA (TSUKASA Co., Ltd.)  Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Board size  Inverter board LV400: 100mm(W)×160mm(H) CPU card : 79mm(W)×66mm(H) Communication board : 89mm(W)×52mm(H)  Heat dissipation measures Operating temperature  Room temperature  Room temperature	Product name	RL78/G24 Motor Control Evaluation Kit		
CPU card RTK0EMG240C00000BJ Communication board RTK0EMXC90Z00000BJ PMSM TG-55L-KA (TSUKASA Co., Ltd.) Isolation Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Board size Inverter board LV400: 100mm(W)×160mm(H) CPU card : 79mm(W)×66mm(H) Communication board : 89mm(W)×52mm(H) Heat dissipation measures Operating temperature Room temperature	Kit model name	RTK0EMG24SS00000BJ		
Communication board RTK0EMXC90Z00000BJ PMSM TG-55L-KA (TSUKASA Co., Ltd.) Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Board size Inverter board LV400: 100mm(W)×160mm(H) CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H) Heat dissipation measures Operating temperature Room temperature	Kit configuration	Inverter board LV400	RTK0EMGPLVB00000BJ	
PMSM Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Inverter board LV400: 100mm(W)×160mm(H) CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H)  Heat dissipation measures Operating temperature  Room temperature  Room temperature  Room temperature		CPU card	RTK0EMG240C00000BJ	
Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Inverter board LV400: 100mm(W)×160mm(H) CPU card: 79mm(W)×66mm(H) CPU card: 79mm(W)×52mm(H)  Heat dissipation measures Operating temperature  Room temperature  Room temperature		Communication board	RTK0EMXC90Z00000BJ	
Inverter board - CPU card: Non-isolated Communication board - CPU board: Isolated  External view  Note: The actual product may differ from this photo.  Inverter board LV400: 100mm(W)×160mm(H) CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H)  Heat dissipation measures Operating temperature  Room temperature  Room temperature		PMSM	TG-55L-KA (TSUKASA Co., Ltd.)	
External view  Note: The actual product may differ from this photo.  Board size  Inverter board LV400: 100mm(W)×160mm(H) CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H) Heat dissipation measures Operating temperature  Room temperature	Isolation	Inverter board - CPU card: Non-isolated		
Note: The actual product may differ from this photo.  Board size  Inverter board LV400: 100mm(W)×160mm(H)  CPU card : 79mm(W)×66mm(H)  Communication board : 89mm(W)×52mm(H)  Heat dissipation measures  Operating temperature  Room temperature		Communication board - CPU board: Isol	ated	
Board size Inverter board LV400: 100mm(W)×160mm(H) CPU card : 79mm(W)×66mm(H) Communication board : 89mm(W)×52mm(H)  Heat dissipation measures Natural air cooling with heat sinks Operating temperature Room temperature	External view			
CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H)  Heat dissipation measures  Natural air cooling with heat sinks  Operating temperature  Room temperature				
CPU card: 79mm(W)×66mm(H) Communication board: 89mm(W)×52mm(H)  Heat dissipation measures  Natural air cooling with heat sinks  Operating temperature  Room temperature	Board size			
Communication board : 89mm(W)×52mm(H)  Heat dissipation measures  Operating temperature  Communication board : 89mm(W)×52mm(H)  Natural air cooling with heat sinks  Room temperature			. ,	
Heat dissipation measures Natural air cooling with heat sinks Operating temperature Room temperature			m(H)	
Operating temperature Room temperature	Heat dissipation measures			
	•			

Table 3.2 Specifications of Low voltage Inverter Board (RTK0EMGPLVB00000BJ)

Item	Specification
Product name	Low voltage Inverter Board for Motor Control Evaluation Kit - LVI400
Board model name	RTK0EMGPLVB00000BJ
Operating input voltage	12V to 50V
Maximum output current	30A (peak current for each phase)
Driving monitor	3-phase PMSM
Current detection method	Detects current using a shunt resistor for 3-phase and DC link.
DC bus voltage detection	Detects using a resistance divider circuit.
3-phase output voltage	Detects using a resistance divider circuit.
detection	
PWM logic	Positive for both upper and lower arms.
Overcurrent detection	Available by specifying the RL78/G24 MCU setting (PWMOPA) (No detection circuit is provided.)
Dead time	1 μs (Recommended value)
Switch	Two tact switches
	Inverter power toggle switch
LEDs	Two LEDs
	Inverter Power LED
	+5V power LED
Connectors	CPU card connector: CNA, CNB
	<ul> <li>Two analog signal input connectors: CN1 and CN2</li> </ul>
Jumper pins	Current Amplifier Switching: magnification is 1/5/50 times: JP7
	Current Amplifier Switching: magnification is 5/50 times: JP8, JP9, JP10
Screw terminals	Power input: P,N
	Motor output: U, V, W
External view	

Note: The actual product may differ from this photo.

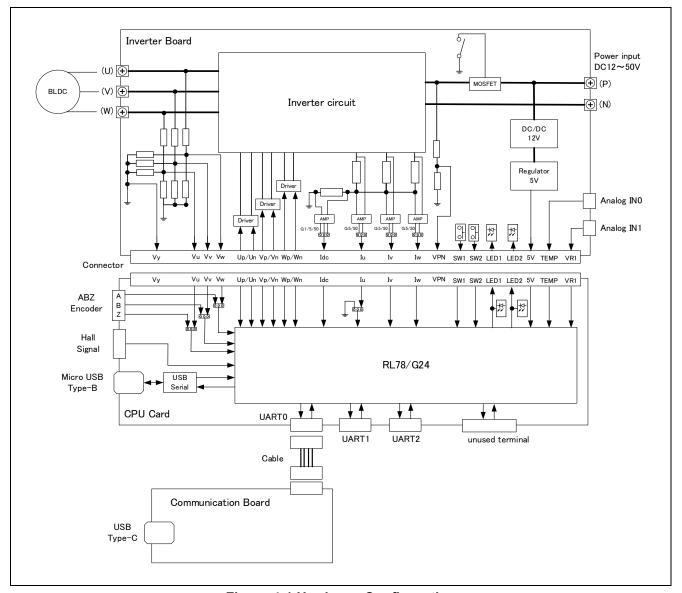
Table 3.3 Specifications of RL78/G24 CPU Card (RTK0EMG240C00000BJ)

item		Specification
Product name		RL78/G24 CPU Card for Motor Control Evaluation Kit
Board model name		RTK0EMG240C00000BJ
Mounted MCU Product name		R7F101GLG2DFB
	CPU maximum	48 MHz
	operating frequency	
	Bit number	16 bit
	Package / Pin number	LQFP / 64pin
	ROM	128 KB
	RAM	12 KB
Input power sup	oply voltage	DC 5V
	. ,	Automatically select one of the following
		Power supply from compatible inverter board
		Power supply from USB connector
Switch		MCU reset switch
LED		Two LEDs
		Two USB communication LED
Connectors		Inverter board connector:CN1,CN2
		ABZ encoder input connector:CN3
		UVW Hall signal input connector:CN4
		COM Port Micro USB connector for debugging:CN5
		Three serial communication connectors: CN6,CN7,CN8
		Unused pin connectors:CN9
Jumper pins		V-phase voltage / Encoder A-phase switching: JP2
		U-phase voltage / Encoder Z-phase switching: JP3
		W phase voltage / Encoder B phase switching: JP4
		W-phase current / GND switching: JP5
外観		W-priase current / GND switching. JP3
		Note: The actual product may differ from this photo.

**Table 4-1 Communication board MC-COM specification** 

item		Specification
Product name		MC-COM Renesas Flexible Motor Control Communication Board
Board model na	ame	RTK0EMXC90Z00000BJ
External view		NYANG NI JONE CONTOLLS CONTOLL
Mounted MCU	Product group	Note: The actual product may differ from this photo.  RX72N group
Mounted MCO	Product group  Product name	R5F572NNDDFB
	CPU maximum	240MHz
	operating frequency	Z4OWITZ
	Bit number	32 bit
	Package / Pin number	LFQFP / 144 pin
	RAM	1M byte
MCU input clock	k	20MHz (Generate with external crystal oscillator)
Input power sup	oply voltage	• DC 5V
		Power is supplied from USB connector
Connector		USB Type-C connector
		Mini USB Typ-B connector (not available for users)
		SCI connector for RMW communication
Isolation		Between SCI connector and MCU
		1kV <sub>RMS</sub> or larger
Switch		MCU reset switch

# 4. Hardware Configuration



**Figure 4-1 Hardware Configuration** 

# 5. Board Layout

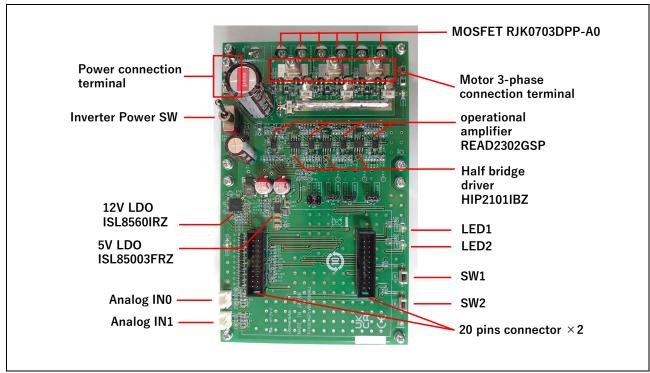


Figure 5-1 Inverter Board LV400

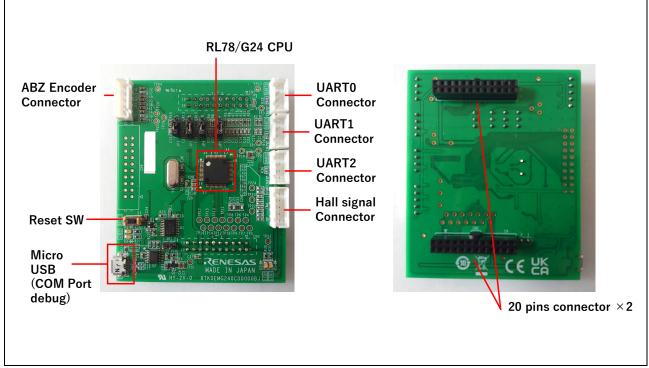


Figure 5-2 CPU Card

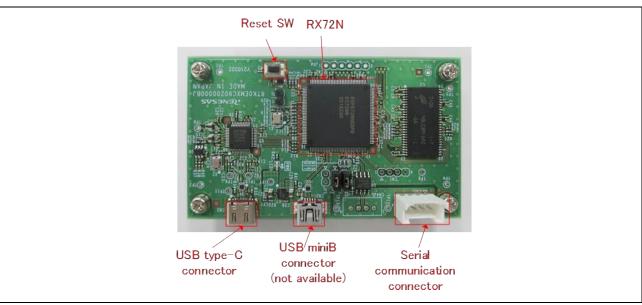


Figure 5-3 CPU Card

#### 6. How to use

This section describes the operating procedures after the product has been opened.

## 6.1 Quick Start Guide 1: Check initial operation.

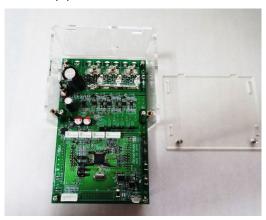
The initial operating program has already been written to the CPU card immediately after the kit is opened. A simple operation check can be performed by connecting the board to the PMSM.

Preparation: Prepare a regulated power supply capable of supplying 24V1A, two cables for connection to the power supply, and a Phillips-head screwdriver.

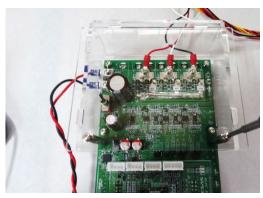
Step 1: Take out the inverter board, PMSM, and cables from the kit's packing box.



Step 2: Remove the screws from the top panel of the inverter board.



Step 3: Screw in the PMSM cable and power cable. Attach the top panel again.



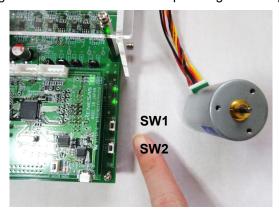
Step 4: Connect the PMSM.



Step 5: Turn on the regulated power supply and confirm that the LED lights up.



Step 6: Confirm that pressing SW1 drives the PMSM and pressing SW2 stops the PMSM.

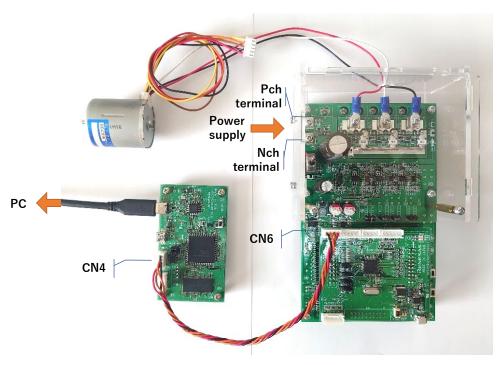


## 6.2 Quick Start Guide 2: Confirming Operation Using Sample Software

This section describes the setup during operation using the sample software.

- Step 1: Connect to the state of Quick Start Guide 1. Power should be turned off or disconnected.
- Step 2: Connect the communication board to the inverter board and connect the communication board to the PC. Connect CN6 on the CPU card to CN4 on the communication board.

Connect the communication board and PC with the supplied USB type-A to C cable.



Step 3: Write the sample software to the CPU card.

Connect the CPU card and PC with a USB type A to micro B cable to write the sample software.

When writing, the COM number of the target CPU card must be selected on the IDE.

Refer to the IDE manual for details.

Step 4: Turn on the power and run the sample software according to the application note of the sample software.

# 7. User Interface Specifications

Table 7.1 Table 7.2 lists the user interface parts on this system.

# **Table 7.1 User Interface (Inverter Board)**

Item	Interface Parts	Function
SW1	Tact switch	Can be defined by user
SW2	Tact switch	Can be defined by user
LED1	Yellow-green LEDs	Can be defined by user
LED2	Yellow-green LEDs	Can be defined by user

# Table 7.2 User Interface (CPU Card)

Item	Interface Parts	Function
RESET	Tact switch (RESET1)	System reset
LED1	Yellow-green LEDs	Can be defined by user
LED2	Yellow-green LEDs	Can be defined by user
RX	Red LEDs	USB to serial communication
TX	Yellow-green LEDs	USB to serial communication

Table 7.3 Table 7.4 lists the connector interface pins on this system.

#### **Table 7.3 Connector Interface**

Item	Pin Count	Function
CNA	20	CPU card connector
CNB	20	CPU card connector
CN1	2	Analog input
CN2	2	Analog input

## **Table 7.4 Connector Interface**

Item	Pin Count	Function
CN1	20	Inverter Board Connectors
CN2	20	Inverter Board Connectors
CN3	5	ABZ encoder
CN4	5	Hall sensor signal input
CN5	-	Micro USB
CN6	4	Serial communication
CN7	4	Serial communication
CN8	4	Serial communication

# 8. Alternate Function Pins

The initial settings and functions of each jumper pin are shown below.

Table 8.1 Initial setting and function of jumper pins (inverter board)

Jumper pin	Default setting	Function
JP7	5-6pin short	1-2pin short: Idc current amplification amplifier 1x 3-4pin short: Idc current amplification amplifier 5x 5-6pin short: Idc current amplification amplifier 50x
JP8	2-3pin short	1-2pin short: lu current amplification amplifier 5x 2-3pin short: lu current amplification amplifier 50x
JP9	2-3pin short	1-2pin short: Iv current amplification amplifier 5x 2-3pin short: Iv current amplification amplifier 50x
JP10	2-3pin short	1-2pin short: Iw current amplification amplifier 5x 2-3pin short: Iw current amplification amplifier 50x

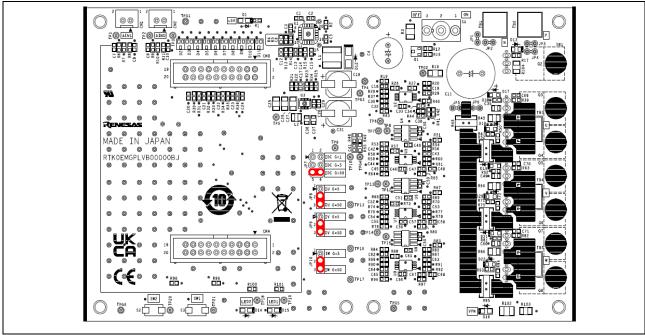


Figure 8-1 Jumper Pin Assignment on Board - Inverter Board

Table 8.2 Initial setting and function of jumper pins (CPU Card)

Jumper pin	Default setting	Function
JP2	1-2pin short	1-2pin short: V-phase voltage
JP3	1-2pin short	2-3pin short: Encoder phase-A 1-2pin short: U-phase voltage
01 0	1-2011 311011	2-3pin short: Encoder phase-Z
JP4	1-2pin short	1-2pin short: W-phase voltage
		2-3pin short: Encoder phase-B
JP5	1-2pin short	1-2pin short: W-phase voltage 2-3pin short: GND

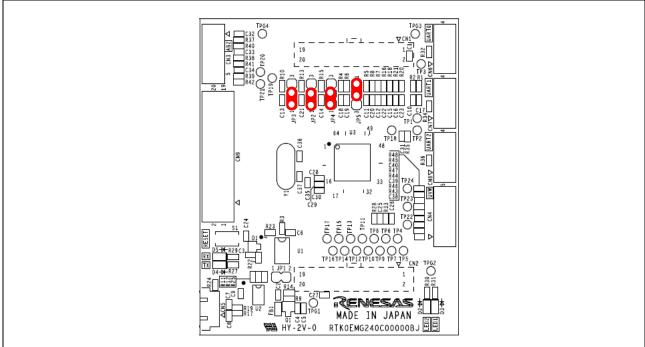


Figure 8-2 Jumper Pin Assignment on Board - Inverter Board

# Table 8.3 Initial setting and function of jumper pins (CPU Card)

Jumper pin	Default setting	Function
JP1	1-2pin open	1-2pin short : Enable pull-up for MD port (Not available) 1-2pin open : Enable pull-up for MD port
JP2	1-2pin short	1-2pin short: Disable pull-up for GPIO(PC6) 1-2pin open: Enable pull-up for GPIO(PC6)
JP3	1-2pin short	1-2pin short : Disable pull-up for GPIO(PC5) 1-2pin open : Enable pull-up for GPIO(PC5)

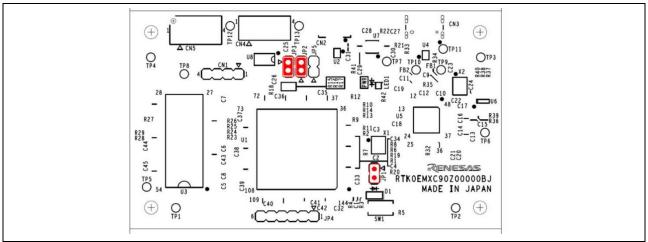


Figure 8-3 Jumper Pin Assignment on Board - Communication Board

# 9. Sample Connection For Use

When using the inverter, connect the inverter board, CPU card, communication board, and PMSM as shown in the **Figure 9-1**. Use a DC power supply or a regulated power supply within the input voltage range of the inverter board.

The figure is a connection example. Please set up and use in accordance with the sample software and application notes to be used.

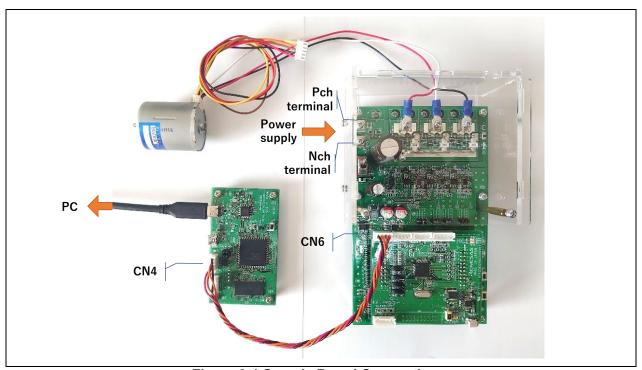


Figure 9-1 Sample Board Connection

# 10. Inverter Board Specifications

#### 10.1 Circuit Functions

#### 10.1.1 Inverter Control Circuit

The inverter control circuit controls the motor using six MOSFETs. The MOSFET uses the 6-phase timer outputs from the microcontroller via the gate driver IC.

The inverter control circuit inputs the DC line voltage, U-phase voltage, V-phase voltage, W-phase voltage, and shunt current to the A/D pins of the microcontroller. The analog values of each voltage and shunt current can thus be measured. See sections **10.1.2** and **0** for details about how to detect the current and voltage, respectively. The current in each phase can be selected with a gain of 5 or 50 times.

**Figure 10-1** shows a schematic diagram of the inverter control circuit. Note that the inputs to the A/D pins may actually pass through a voltage diver or an offset device. See the circuit diagram for details.

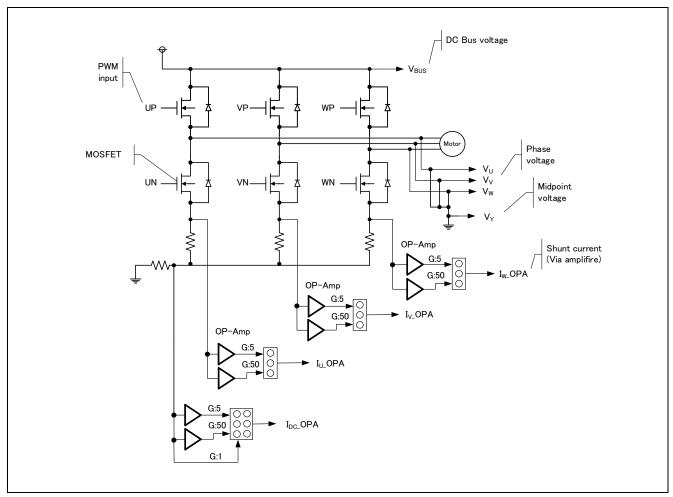


Figure 10-1 Schematic Diagram of Inverter Control Circuit

# 10.1.2 Current Detection Circuit

The current detection circuit is integrated to measure the U-phase, V-phase, and W-phase current. The current detection circuit is configured by mounting a shunt resistor for the U-phase, V-phase, and W-phase. The voltage drop generated when the current passes through the shunt resistor is amplified by the operational amplifier and then input to the microcontroller. The equation (1) below shows the relationship between the current lin running through the shunt resistor and the voltage Vout input to the microcontroller. The gain can be changed by switching the jumper short in each phase.

Gain x5: Vout[V] = Iin[A] × Rs[
$$\Omega$$
] ×  $\frac{B=10k\Omega}{A=2k\Omega}$  + 2.5 (1)

Gain x50: Vout[V] = Iin[A] × Rs[
$$\Omega$$
] ×  $\frac{B=100k\Omega}{A=2k\Omega}$  + 2.5 (2)

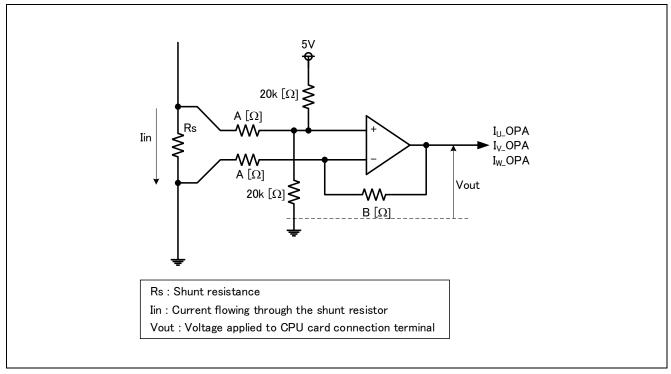


Figure 10-2 Schematic Diagram of Current Detection Circuit

## 10.1.3 Output Voltage Detection Circuit

The inverter board integrates a circuit used to input the bus line voltage and 3-phase output voltage (U-phase, V-phase, and W-phase) to the A/D pins of the microcontroller via a resistance voltage divider. The equation (3) below shows the relationship between the 3-phase output voltage, bus line voltage, and detection voltage.

$$Vout[V] = \frac{470}{10 \times 10^3 + 470} \times Vin[V] (3)$$

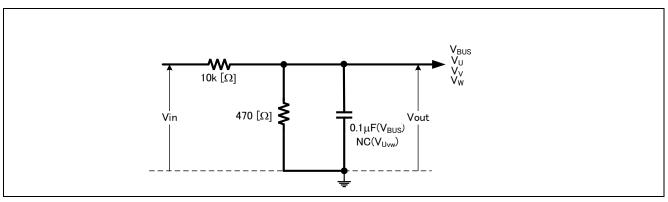


Figure 10-3 Schematic Diagram of Output Voltage Detection Circuit

# 10.1.4 Voltage Generation Circuit

This board generates the voltage of 12V and 5V from the main power supply (24V).

Item	Input Voltage (Typ.) [V]	Output Voltage (Typ.) [V]	Output Current (Max.) [A]	Used for:
12V generation	12~50	12	2	<ul> <li>5V generation</li> </ul>
				Gate driver IC
5V generation	12	5	3	Power supply for MCU

**Table 10.1 Voltage Generation Circuit** 

## 10.1.5 LEDs

This board integrates two LEDs. The user can control the LEDs from the microcontroller.

#### Table 10.2 LEDs

LED No.	Connector terminal	Pin Signal Level	LED State
LED1	Inverter board: CNA_1	High	Off
	CPU card: CN2_1	Low	On
LED2	Inverter board: CNA_2	High	Off
	CPU card: CN2_2	Low	On

#### 10.1.6 Tact Switch

This board integrates two tack switches: SW1 and SW2. The use can define the behavior of the switches.

**Table 10.3 Tact Switch** 

SW No.	Connector terminal	Pin Signal Level	Switch Setting
SW1	Inverter board: CNA_13	High	Off
	CPU card: CN2_13	Low	On
SW2	Inverter board: CNA_14	High	Off
	CPU card: CN2_14	Low	On

# 10.1.7 Analog Signal Input Connector

This board integrates connectors for inputting analog signals. **Table 10.4** lists the pin assignment for each connector.

Table 10.4 Analog Signal Input Connectors (Inverter board)

Connector No.	Connector terminal	Pin No.	Pin Function
CN1(ANI1)	Inverter board: CNB_9	1	5V
	CPU card: CN1_9	2	Analog input
CN7(ANI0)	Inverter board: CNB_15	1	5V
	CPU card: CN1_15	2	Analog input

When using these connectors, be sure to connect them to the compatible connector shown in **Table 10.5** below.

**Table 10.5 Compatible Connector** 

Part	Part No.	Manufacturer
Connector	XHP-2	J.S.T. Mfg. Co. Ltd.

## **Table 10.6 Analog Signal Input Voltage Range**

Item	Specification
Input voltage range [V]	0 to AVCC

# 10.2 CPU card connector

Two 20-pin connectors are provided for connection to the CPU card.

Table 10.7 CPU card connector (CNA)

Pin No.	Output direction	Function
1	Input	LED1
2	Input	LED2
3	-	-
4	-	-
5	-	-
6	-	-
7	Input	PWM Output (W <sub>n</sub> )
8	Input	PWM Output (V <sub>n</sub> )
9	Input	PWM Output (U <sub>n</sub> )
10	Input	PWM Output (W <sub>p</sub> )
11	Input	PWM Output (V <sub>p</sub> )
12	Input	PWM Output (U <sub>p</sub> )
13	Output	SW1
14	Output	SW2
15	Output	+5V
16	Output	+5V
17	-	GND
18	-	GND
19	-	-
20	-	-

# Table 10.8 CPU card connector (CNA)

Pin No.	Output direction	Function
1	-	AVCC1
2	-	AVCC2
3	-	-
4	-	-
5	Output	U-phase current
6	Output	V-phase current
7	Output	W-phase current
8	Output	Inverter Voltage
9	Output	Analog voltage
10	Output	U-phase voltage
11	Output	V-phase voltage
12	Output	W-phase voltage
13	-	-
14	Output	PFC current / DC link current
15	Output	analog voltage
16	Output	mid-point voltage
17	-	VCCIO1
18	-	VCCIO1
19	-	GND1
20	-	GND2

## 11. CPU card specifications

This chapter describes CPU card specifications.

#### 11.1 Circuit Functions

## 11.1.1 Power Supply

During operation, 5V is supplied from the inverter board. During writing, power should be supplied from the USB connector. Do not connect to the USB except when writing. (Do not perform debugging operation with the inverter running.) Turn off the power supply of the inverter board when it is connected to the inverter board.

#### 11.1.2 On-Chip Debug Function

On-chip debug function via serial communication is provided using USB driver IC. Communication with the RL78 microcontroller is performed via serial communication by dedicated UART using the TOOLTxD and TOOLRxD pins on the RL78 microcontroller. For details, see RL78 Debug Function Using Serial Port (R20AN0632).

#### 11.1.3 LEDs

This board integrates two LEDs. The user can control the LEDs from the microcontroller.

Table 11.1 LEDs

LED No.	Connector terminal	Pin Signal Level	LED State
LED1	Inverter board: CNA_1	High	Off
	CPU card: CN2_1	Low	On
LED2	Inverter board: CNA_2	High	Off
	CPU card: CN2_2	Low	On

## 11.1.4 Serial Communication Connector

A connector is provided for serial communication connection. Table 10.2 shows the pin assignments for each connector. When performing serial communication using RMW, connect the communication board to the target connector according to the sample software and application note.

**Table 11.2 Pin Assignment of Serial Communication Connectors (CPU Card)** 

Connector No.	Pin No.	Pin Function
CN6	1	5V
UART0	2	Transmission
	3	Reception
	4	GND
CN7	1	5V
UART1	2	Transmission
	3	Reception
	4	GND
CN8	1	5V
UART2	2	Transmission
	3	Reception
	4	GND

When using these connectors, be sure to connect them to the compatible connector shown in **Table 11.3** below.

**Table 11.3 Compatible Connector** 

Part	Part No.	Manufacturer
Connector	XHP-4	J.S.T. Mfg. Co. Ltd.

#### 11.1.5 Hall Sensor Signal Input Connector

This board integrates a connector for Hall sensor signal input. This connector enables the input of the Hall sensor signal from the supplied PMSM. The Hall sensor signal is pulled up to 5 V and then passed through an RC filter before being inputted to the board. **Table 11.4** lists the pin assignment of the Hall sensor signal input connector.

Table 11.4 Pin Assignment of Hall Sensor Signal Input Connector

Connector No.	Pin No.	Pin Function
	1	5V
	2	GND
CN4	3	HU
	4	HV
	5	HW

When using this connector, be sure to connect it to the compatible connector shown in **Table 11.5** below.

**Table 11.5 Compatible Connector** 

Part	Part No.	Manufacturer
Connector	XHP-5	J.S.T. Mfg. Co. Ltd.

#### 11.1.6 Encoder Signal Input Connector

The encoder signal input function can input the encoder signals from the target motor. The encoder signal is pulled up to 5 V and passed through an RC filter before being input to the microcontroller. **Table 11.6** lists the pin assignment of the encoder signal input connector.

**Table 11.6 Pin Assignment of Encoder Signal Input Connector** 

Connector No.	Pin No.	Pin Function
	1	5V
	2	GND
CN3	3	A-phase
	4	B-phase
	5	Z-phase

When using this connector, be sure to connect it to the compatible connector shown in **Table 11.7** below.

**Table 11.7 Compatible Connector** 

Part	Part No.	Manufacturer
Connector	XHP-5	J.S.T. Mfg. Co. Ltd.

#### 11.1.7 Reset Circuit

This board integrates a reset circuit for resetting the microcontroller at power-on reset and external reset. To apply an external reset to the microcontroller, press the tact switch (RESET1).

## 11.1.8 Inverter board connection connector

Two 20-pin connectors are provided for connection to the inverter board.

Table 11.8 Inverter board connection connector (CN1)

Pin No.	Output direction	Function
1	-	AVCC1
2	-	AVCC2
3	-	-
4	-	-
5	Input	U-phase current
6	Input	V-phase current
7	Input	W-phase current
8	Input	Inverter Voltage
9	Input	Analog voltage
10	Input	U-phase voltage
11	Input	V-phase voltage
12	Input	W-phase voltage
13	-	-
14	Input	PFC current / DC link current
15	Input	analog voltage
16	Input	mid-point voltage
17	-	VCCIO1
18	-	VCCIO1
19	-	GND1
20	-	GND2

Table 11.9 CPU card connector (CN2)

Pin No.	Output direction	Function
1	Input	LED1
2	Input	LED2
3	-	-
4	-	-
5	-	-
6	-	-
7	Input	PWM Output (W <sub>n</sub> )
8	Input	PWM Output (V <sub>n</sub> )
9	Input	PWM Output (U <sub>n</sub> )
10	Input	PWM Output (W <sub>p</sub> )
11	Input	PWM Output (V <sub>p</sub> )
12	Input	PWM Output (U <sub>p</sub> )
13	Output	SW1
14	Output	SW2
15	Output	+5V
16	Output	+5V
17	-	GND
18	-	GND
19	-	1
20	-	-

# 11.1.9 List of RL78/G24 Pin Functions

# Table 11.10 List of RL78/G24 Pin Functions (1/2)

Pin No.	R7F101GLG2DFB Pin Name	Function
1	P120/ANI19/IVCMP0/PGAI0/TRGIDZ	U-phase voltage measurement / Encoder Z-phase input
2	P43	LED2 on/off control
3	P42	LED1 on/off control
4	P41/(TRJIO0)	VRL
5	P40/TOOL0	Debugger data Input/output
6	RESET	System reset input
7	P124	OPEN
8	P123	OPEN
9	P137/INTP0	Cutoff signal input
10	P122/X2	X2
11	P121/X1	X1
12	REGC	REGC
13	Vss	Ground potential for pins
14	EVss0	EVss0
15	Vdd	Positive power supply for pins
16	EVdd0	EVdd0
17	P60	OPEN
18	P61	OPEN
19	P62	OPEN
20	P63/CCD03	nINVERS
21	P31	OPEN
22	P77/ TxD2	Serial communication
23	P76/ RxD2	Serial communication
24	P75/ TRDIOD1	PWM output (Up)
25	P74/ TRDIOB1	PWM output (U <sub>n</sub> )
26	P73/ TRDIOC1	PWM output (V <sub>p</sub> )
27	P72/ TRDIOA1	PWM output (W <sub>p</sub> )
28	P71/ TRDIOD0	PWM output (V <sub>n</sub> )
29	P70/TRDIOB0	PWM output (W <sub>n</sub> )
30	P06	DC link current detection (A/D, PGA, CMP)
31	P05	W-phase voltage measurement (CMP1)
32	P30	V-phase voltage measurement (CMP1)
33	P50/ TOOLRxD	Debugger data Input
34	P51/ TOOLTxD	Debugger data output
35	P52/(INTP1)	Hall sensor input (HU)
36	P53/(INTP2)	Hall sensor input (HV)
37	P54/(INTP3)	Hall sensor input (HW)
38	P55	OPEN
39	P17/ ANI27	Analog signal input VR1
40	P16/ANI26	Analog signal input Vy
41	P15	OPEN
42	P14/ ANI24	Analog signal input PFC_G
43	P13/ANI23	Analog signal input Vdc
44	P12/ TxD0_1	Serial communication
45	P11/RxD0_1	Serial communication

# Table 11.11 List of RL78/G24 Pin Functions (2/2)

Pin No.	R7F101GLG2DFB Pin Name	Function
46	P10/ANI20	OPEN
47	P146/ANI28	OPEN
48	P147/ANI18/IVCMP3/PGAI3	Analog Signal Input Ipfc
49	P27/ANI7	Analog signal input Vac
50	P26/ANI6	Analog signal input Vdc
51	P25/ANI5	Analog signal input Vtemp
52	P24/ANI4	Analog signal input lv
53	P23/ANI3/PGAGND	Analog signal input lw / GND
54	P22/ANI2/PGAI4	Analog signal input lu
55	P21/ANI1/AVREFM	AGND
56	P20/ANI0/AVREFP	AVCC
57	P130	OPEN
58	P04	Tact switch (SW2)
59	P03/RxD1	Serial communication
60	P02/TxD1	Serial communication
61	P01/ANI30/IVCMP2/PGAI2/TRGCLKB	W-phase voltage measurement / Encoder B-phase input (pin shared)
62	P00/ANI29/IVCMP1/PGAI1/TRGCLKA	V-phase voltage measurement / Encoder A-phase input (pin shared)
63	P141	Tact switch (SW1)
64	P140	OPEN

#### 12. Communication Board Functions

This section describes the specifications of the communication board.

#### 12.1 Function

#### 12.1.1 Power Supply

The power of this product is supplied via a USB connector.

#### 12.1.2 USB communication

This product is equipped with a USB type-C connector for communication with a PC when using RMW.

#### 12.2 Serial Communication

This product has two connectors for serial communication connection in order to communicate with the target MCU when using RMW, etc. The pin assignments are shown in **Table 12.1** and **Table 12.2** When using the communication cable bundled with this product, use CN5.

The serial communication connector and the MCU (RX72N) are connected via a digital isolator, so the communication board and the CPU board with the target MCU are isolated.

Table 12.1 Serial communication connector (CN5) pin assignment

Pin No.	Function	Comment
1	VCC	
2	RXD	Connect to TXD of target MCU
3	TXD	Connect to RXD of target MCU
4	GND	

Table 12.2 Serial communication connector (CN4) pin assignment

Pin No.	Function	Comment
1	VCC	
2	RXD	Connect to TXD of target MCU
3	TXD	Connect to RXD of target MCU
4	GND	

# 13. Design and Manufacture Information

You can obtain information on the design and manufacture of this product from renesas.com.

# 14. Website and Support

In order to learn, download tools and documents, apply technical support for RL78 family MCU and its kit, visit the following website.

- · RL78 Product Information renesas.com/rl78
- · Renesas Support renesas.com/support

# **Revision History**

		Description	
Rev.	Date	Page	Summary
1.00	27/11/2023		New create

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

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#### 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

#### 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

#### 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

#### 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

#### 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

#### 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

#### 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

#### 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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